# MILITARY GRADE 10BASE - T INTERFACE MODULE





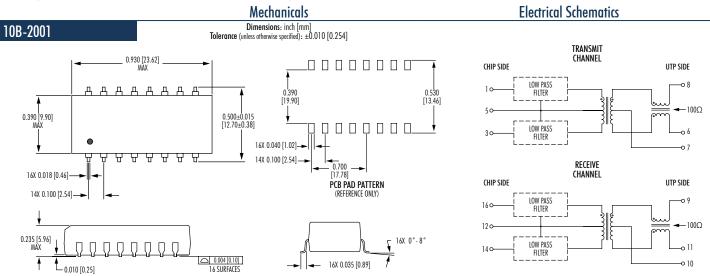
- **iNRC**©RE
- Fully integrated 10Base-T module for adapter, hub, and motherboard applications.
- Designed to meet IEEE802.3i-1993 10Base-T specifications.
- Operating Temperature: -40°C to +85°C
- Low profile surface mount package
- Moisture Sensitivity Level: 3
- Parts can be screened to MIL-T-21038 and other military specific requirements.

Electrical Specifications @ 25°C															
		Insertion Loss (dB MAX)		Attenuation XMIT (dB MIN) <sup>1</sup>		Return Loss (dB MIN)		Crosstalk (dB MIN)		CM Rejection (dB MIN)					Pri-Sec
	Part Number	1 MHz	10 MHz	30 MHz	50 MHz	5 MHz	10 MHz	5 MHz	10 MHz	5 MHz	10 MHz	50 MHz	100 MHz	200 MHz	Isolation (Vrms)
	10B-2001	1.0	1.0	30	35	18	15	35	35	60	60	55	50	45	1500

Receive and transmit sides meet IEEE 8023i-1993 sepcification, transmit side is enhanced for FCC/VDE class B system emissions requirement.

#### NOTES:

- 1. Add suffix "NL" for RoHS compliant version; i.e. 10B-1001 becomes 10B-2001NL.
- 2. For Tape & Reel packaging, add "T" suffix at the end of the part number: i.e. 10B-2001NLT
- 3. Specifications reflect filter sections, additional attenuation is due to pre-distortion resistors.



#### **APPLICATION NOTES:**

The module contains low pass filters, isolation transformers, and common mode chokes. These components provide impedance matching, equipment isolation, and EMI compression to comply with IEEE requirements. User compliance with FCC/CSPR class B requirements can be achieved by applying rigorous design guidelines to suppress noise mechanisms. Attention to high frequency signal paths, proper PCB grounding techniques, and component placement is critical. Pins 5 and 12, when grounded, provide noise return paths.

At least one of these (typically pin 12) must be coupled with bypass capacitor. Recommended module orientation with respect to RJ45 connector is illustrated in the application circuit. Output pins 6 through 11 should be routed with short, matched traces to the connector for optimum EMI performance. The robust mechanical package withstands IR reflow temperatures up to 235°C. Compliant leads provide excellent solder-joint reliability with K.002 coplanarity. Modules are shippped in tubes.



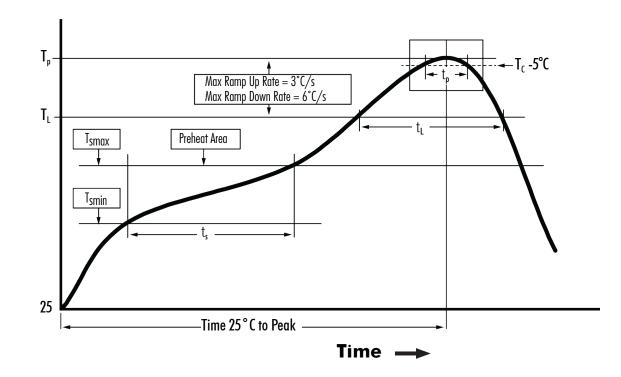
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Ruggedized

### Tin/Lead Recommended Reflow Profile (Based on J-STD-020D)



T <sub>smin</sub> (°C)	T <sub>smax</sub> (°C)	т <sub>.</sub> (°С)	T <sub>p</sub> (°C MAX)	t <sub>s</sub> (s)	t <sub>L</sub> (s)	t <sub>e</sub> (s MAX)	Ramp-up rate (T <sub>L</sub> to T <sub>P</sub> )	Ramp-down rate (T <sub>P</sub> to T <sub>L</sub> )	Time 25°C to peak temperature (s MAX)
100	150	183	235	60 - 120	60 - 150	20	3°C/s MAX	6°C/s MAX	360

NOTES:

1. All temperatures measured on the package leads.

2. Maximum times of reflow cycle: 2



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